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3725

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Harry M. Siegel, et al.  
Serial No.: 10/062,595  
Filed: January 31, 2002  
For: SYSTEM AND METHOD FOR ALIGNING AN  
INTEGRATED CIRCUIT DIE ON AN INTEGRATED  
CIRCUIT SUBSTRATE  
Group No.: 3725  
Examiner: David B. Jones

**MAIL STOP AMENDMENT**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT AND RESPONSE TO OFFICE ACTION**

In response to the Office Action dated December 28, 2004, please amend the above-identified patent application as follows.